



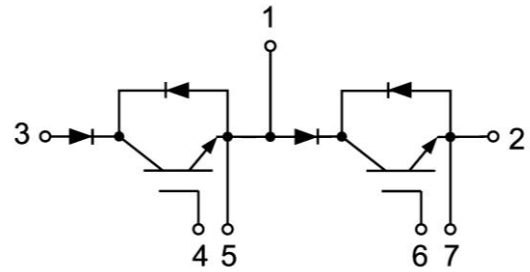
GT100TD120T1VH

IGBT Module

Preliminary Data

Features:

- Field Stop Trench Gate IGBT
- Short Circuit Rated >10 μ s
- Low Saturation Voltage
- Low Switching Loss
- 100% RBSOA Tested (2xI_c)
- Low Stray Inductance
- Lead Free, Compliant with RoHS Requirement



Applications:

- Welding Machine, Cutting Machine
- Plating Power Supply, Induction Heating
- SMPS, UPS

Maximum Rated Values of IGBT (T_C=25°C unless otherwise specified)

V _{CES}	Collector-Emitter Blocking Voltage		1200	V
V _{GES}	Gate-Emitter Voltage		±20	V
I _C	Continuous Collector Current	T _C = 100°C	100	A
		T _C = 25°C	200	A
I _{CM}	Repetitive Peak Collector Current	T _J = 175°C	200	A
t _{sc}	Short Circuit Withstand Time		>10	μs
P _D	Maximum Power Dissipation per IGBT	T _C = 25°C T _{Jmax} = 175°C	714	W



Electrical Characteristics of IGBT ($T_C=25^\circ\text{C}$ unless otherwise specified)

Static Characteristics

Symbol	Description	Conditions	Min	Typ	Max	Unit
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=1\text{mA}$, $V_{CE}=V_{GE}$	5.0	5.5	6.6	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C=100\text{A}$, $V_{GE}=15\text{V}$	$T_J=25^\circ\text{C}$	1.70	2.00	V
			$T_J=125^\circ\text{C}$	1.90		V
			$T_J=150^\circ\text{C}$	1.90		V
I_{CES}	Collector-Emitter Leakage Current	$V_{GE}=0\text{V}$, $V_{CE}=V_{CES}$, $T_J=25^\circ\text{C}$			1	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=\pm 20\text{V}$, $V_{CE}=0\text{V}$, $T_J=25^\circ\text{C}$			200	nA
C_{ies}	Input Capacitance			8.03		nF
C_{oes}	Output Capacitance	$V_{CE}=25\text{V}$, $V_{GE}=0\text{V}$, $f=1\text{MHz}$		1.22		nF
C_{res}	Reveres Transfer Capacitance			0.59		nF

Switching Characteristics

$t_{d(on)}$	Turn-on Delay Time	$V_{CC}=600\text{V}$, $I_C=100\text{A}$, $R_{Gon}=1\Omega$, $V_{GE}=\pm 15\text{V}$, Inductive Load	$T_J=25^\circ\text{C}$	228		ns
			$T_J=125^\circ\text{C}$	250		
			$T_J=150^\circ\text{C}$	254		
t_r	Rise Time	$V_{CC}=600\text{V}$, $I_C=100\text{A}$, $R_{Goff}=1\Omega$, $V_{GE}=\pm 15\text{V}$, Inductive Load	$T_J=25^\circ\text{C}$	63		ns
			$T_J=125^\circ\text{C}$	67		
			$T_J=150^\circ\text{C}$	69		
$t_{d(off)}$	Turn-off Delay Time	$V_{CC}=600\text{V}$, $I_C=100\text{A}$, $R_{Goff}=1\Omega$, $V_{GE}=\pm 15\text{V}$, Inductive Load	$T_J=25^\circ\text{C}$	269		ns
			$T_J=125^\circ\text{C}$	279		
			$T_J=150^\circ\text{C}$	284		
t_f	Fall Time	$V_{CC}=600\text{V}$, $I_C=100\text{A}$, $R_{Goff}=1\Omega$, $V_{GE}=\pm 15\text{V}$, Inductive Load	$T_J=25^\circ\text{C}$	184		ns
			$T_J=125^\circ\text{C}$	291		
			$T_J=150^\circ\text{C}$	317		
E_{on}	Turn-on Switching Loss	$V_{CC}=600\text{V}$, $I_C=100\text{A}$, $R_{Gon}=1\Omega$, $V_{GE}=\pm 15\text{V}$, $di/dt=1387\text{A}/\mu\text{s}$ ($T_J=150^\circ\text{C}$), Inductive Load	$T_J=25^\circ\text{C}$	3.1		mJ
			$T_J=125^\circ\text{C}$	4.3		
			$T_J=150^\circ\text{C}$	4.8		



E _{off}	Turn-off Switching Loss	V _{CC} =600V, I _C =100A, R _{Goff} =1Ω, V _{GE} =±15V, du/dt=4448V/μs(T _J =150°C), Inductive Load	T _J =25°C	5.28	mJ
			T _J =125°C	8.33	
			T _J =150°C	9.30	
Q _g	Total Gate Charge	V _{GE} =+15V...-15V	T _J =25°C	745	nC
R _{g internal}	Internal Gate Resistance		T _J =25°C	7.50	Ω
RBSOA	I _C =200A, V _{CC} =1050V, V _P =1200V, R _{Goff} =1Ω, V _{GE} =+15V to 0V, T _J =150°C			Trapezoid	
SC data	V _{CC} =600V, t _p =10us, V _{ge} =+/-15V, R _{Gon} =1ohm, R _{Goff} =1ohm, T _J =25°C			575	A
R _{θJC}	IGBT Thermal Resistance: Junction-To-Case			0.21	°C/W

Diode, Clamp

Maximum Rated Values (T_C = 25°C unless otherwise specified)

V _{RRM}	Repetitive Peak Reverse Voltage	1200	V
I _F	Diode Continuous Forward Current	100	A
I _{FM}	Peak FWD Current Repetitive	200	A

Electrical Characteristics of FWD (T_C=25°C unless otherwise specified)

Symbol	Description	Conditions	Min	Typ	Max	Unit
V _{FM}	Forward Voltage	I _F =100A	T _J =25°C	1.70		V
			T _J =125°C	1.80		
			T _J =150°C	1.80		
t _{rr}	Reverse Recovery Time	I _F =100A, -diF/dt =1911A/μs(T _J =150°C), V _R =600V, V _{GE} =-15V	T _J =25°C	260		ns
			T _J =125°C	396		
			T _J =150°C	454		
I _{rr}	Peak Reverse Recovery Current	I _F =100A, -diF/dt =1911A/μs(T _J =150°C), V _R =600V, V _{GE} =-15V	T _J =25°C	92		A
			T _J =125°C	104		
			T _J =150°C	105		



Q _{rr}	Reverse Recovery Charge	I _F =100A, -diF/dt =1911A/μs(T _J =150°C), V _R =600V, V _{GE} =-15V	T _J =25°C	10.2	μC
			T _J =125°C	16.8	
			T _J =150°C	19.2	
E _{rec}	Reverse Recovery Energy	I _F =100A, -diF/dt =1911A/μs(T _J =150°C), V _R =600V, V _{GE} =-15V	T _J =25°C	4.83	mJ
			T _J =125°C	7.92	
			T _J =150°C	9.13	
R _{θJC}	Diode Thermal Resistance: Junction-To-Case			0.34	°C/W

Diode, Inverter

Maximum Rated Values (T_C = 25°C unless otherwise specified)

V _{RRM}	Repetitive Peak Reverse Voltage	1200	V
I _F	Diode Continuous Forward Current	75	A
I _{FM}	Diode Maximum Forward Current	150	A

Electrical Characteristics of Diode (T_C=25°C unless otherwise specified)

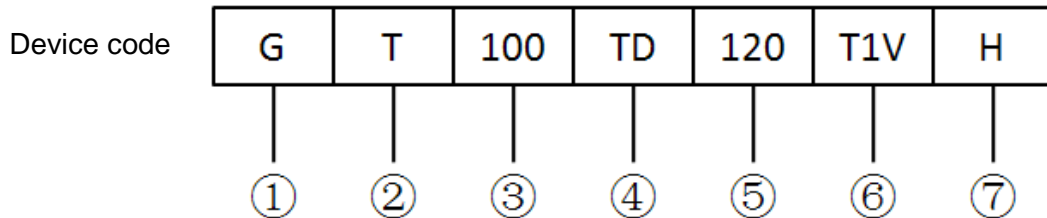
Symbol	Description	Conditions	Min	Typ	Max	Unit
V _{FM}	Forward Voltage	I _F =75A	T _J =25°C	2.10		V
			T _J =125°C	2.20		
t _{rr}	Reverse Recovery Time		T _J =25°C	204		ns
			T _J =125°C	388		
I _{rr}	Peak Reverse Recovery Current	I _F =75A, -diF/dt =1738A/μs(T _J =125°C), V _R = 600V, V _{GE} = -15V	T _J =25°C	47		A
			T _J =125°C	64		
Q _{rr}	Reverse Recovery Charge		T _J =25°C	4.56		μC
			T _J =125°C	9.42		
E _{rec}	Reverse Recovery Energy		T _J =25°C	1.67		mJ
			T _J =125°C	3.60		
R _{θJC}	Diode Thermal Resistance: Junction-To-Case				0.425	°C/W



Module

Symbol	Description	Min	Typ	Max	Unit
V _{iso}	Isolation Voltage (All Terminals Shorted)	f = 50Hz, 1minute	2500		V
T _J	Maximum Junction Temperature			175	°C
T _{JOP}	Maximum Operating Junction Temperature Range	-40		+150	°C
T _{stg}	Storage Temperature	-40		+125	°C
CTI	Comparative Tracking Index	200			
R _{θCS}	Case-To-Sink Thermally (Conductive Grease Applied)			0.07	°C/W
T	Power Terminals Screw:M5	3.0		5.0	N·m
T	Mounting Screw:M6	4.0		6.0	N·m
G	Weight		165		g

Ordering Information Table



- ① - IGBT Module
- ② - Field Stop Trench Gate IGBT
- ③ - Rated Current (100=100A)
- ④ - Circuit Configuration (Half Bridge、Clamp Diode on Collector)
- ⑤ - Rated Voltage (120=1200V)
- ⑥ - Package Type
- ⑦ - Test Level (Pass the Important Reliability Test-Industrial Grade)

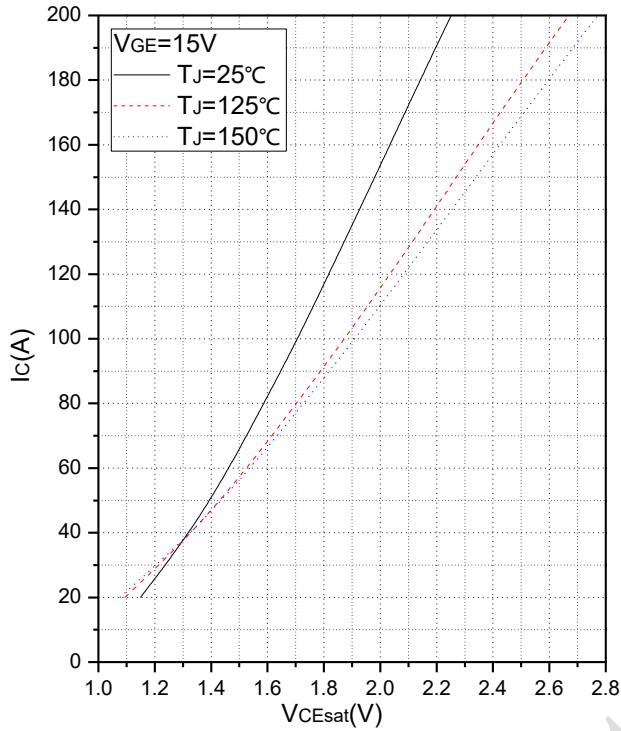


Fig.1 Typical Saturation Voltage Characteristics

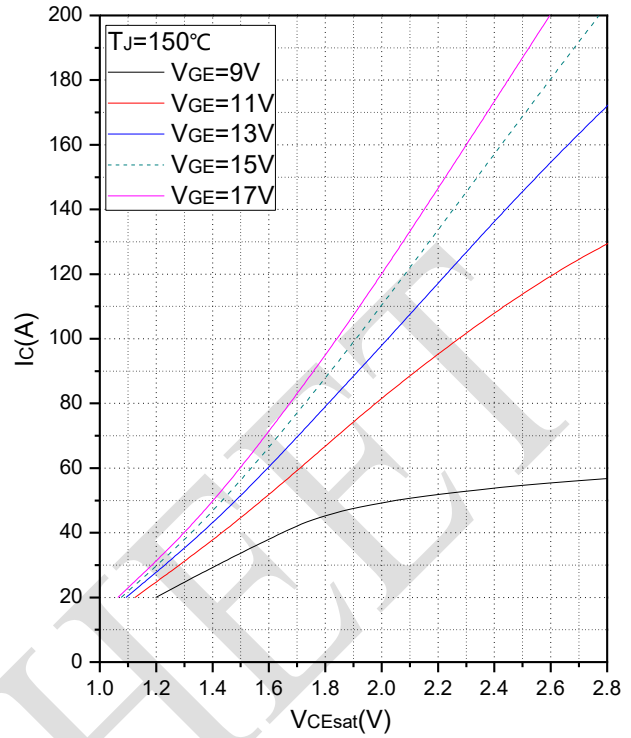


Fig.2 Typical Output Characteristics

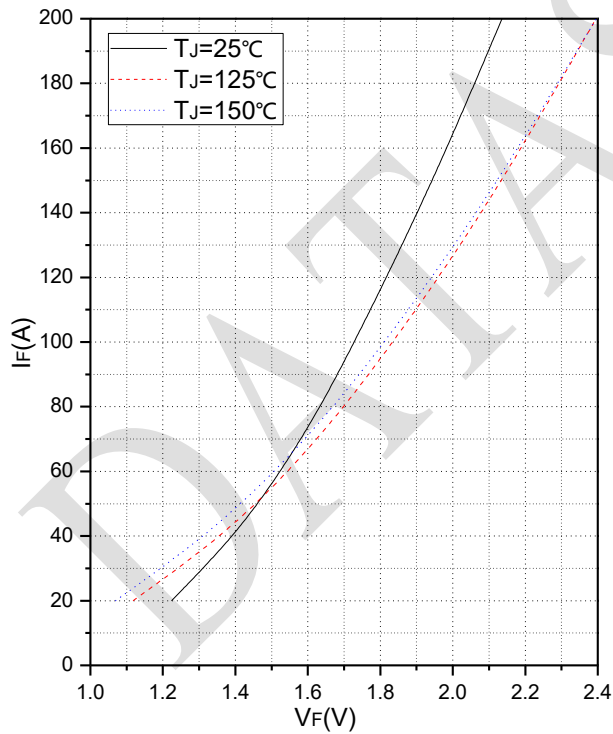


Fig.3 Forward Characteristics of FWD-Inverter

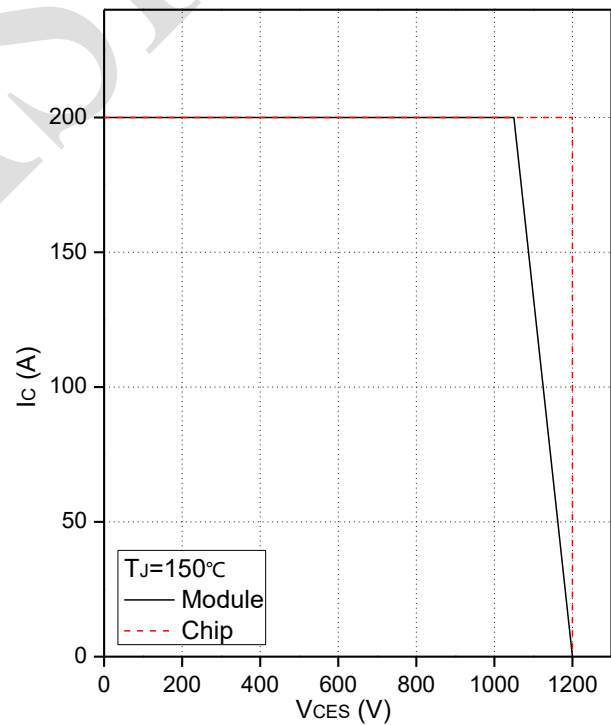


Fig.4 Reverse Bias Safe Operation Area (RBSOA)

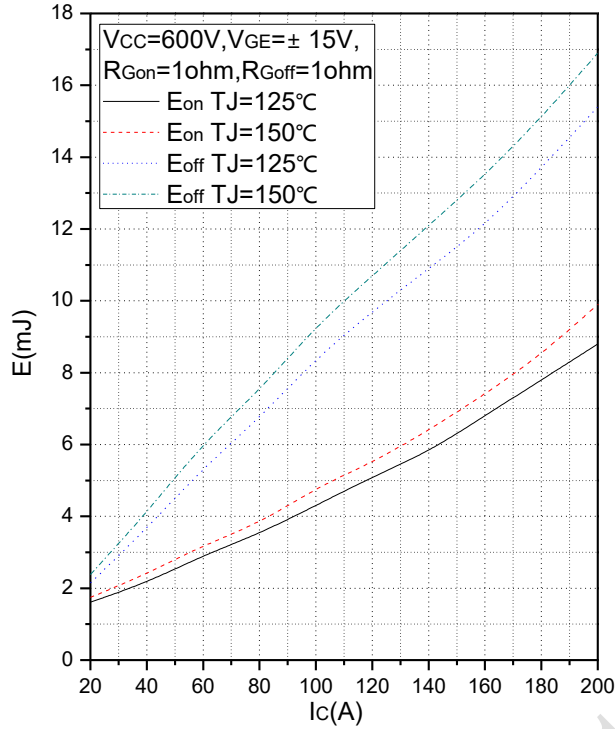


Fig.5 Typical Switching Loss vs. Collector Current

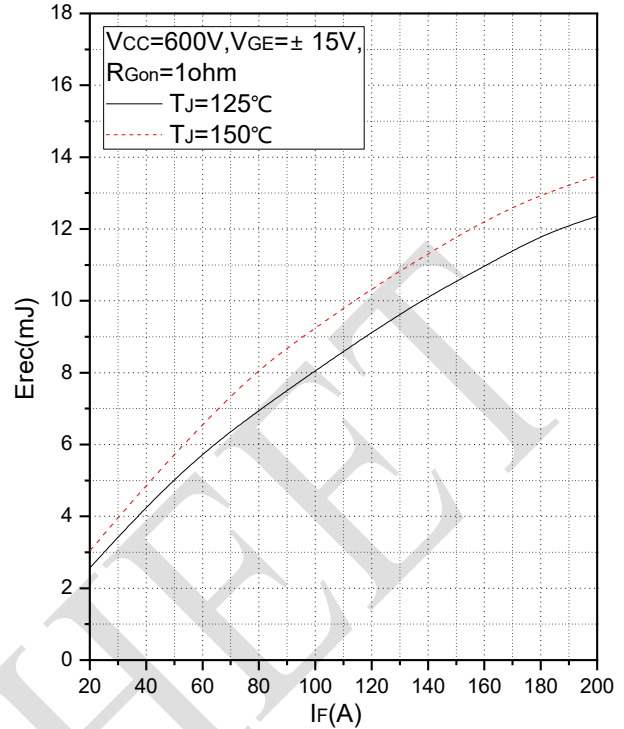


Fig.6 Typical Switching Loss vs. Forward Current

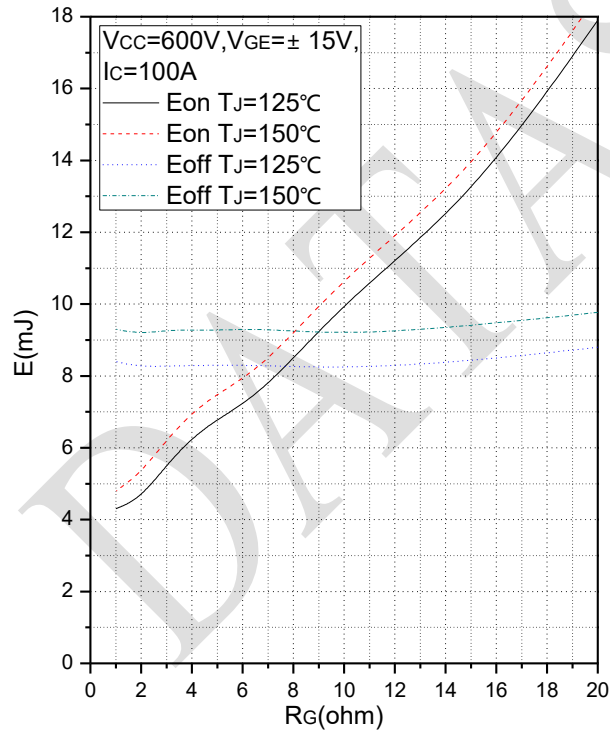


Fig.7 Typical Switching Loss vs. Gate Resistance

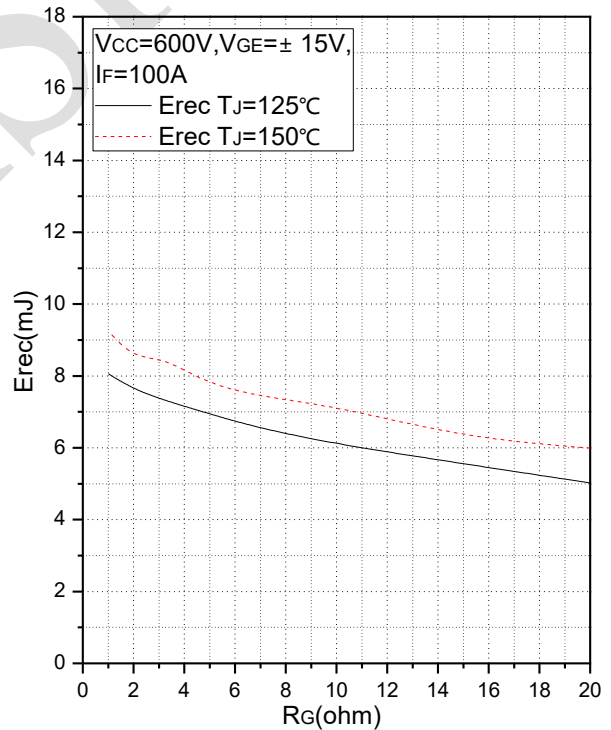


Fig.8 Typical Switching Loss vs. Gate Resistance

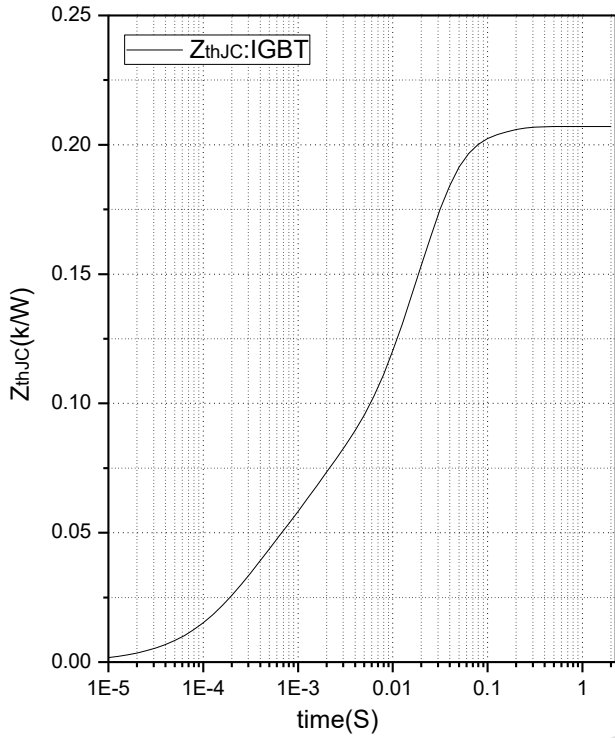


Fig.9 Transient Thermal Impedance

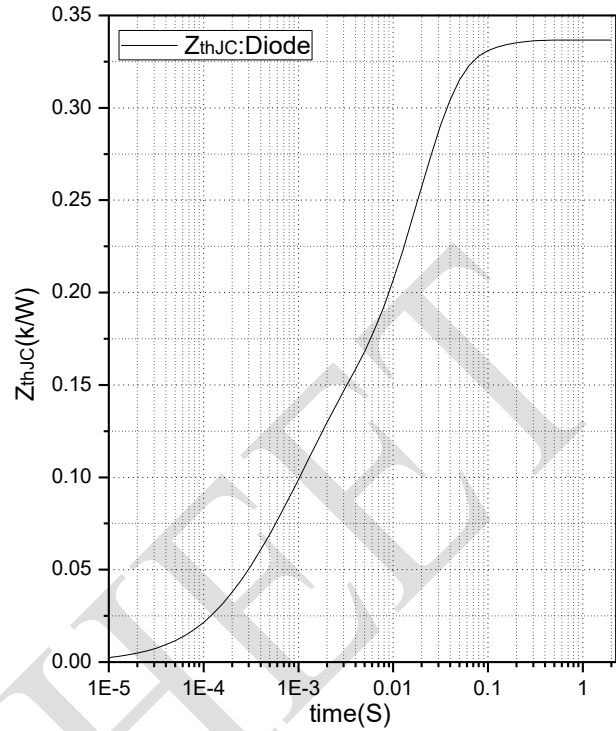


Fig.10 Transient Thermal Impedance-Inverter Diode

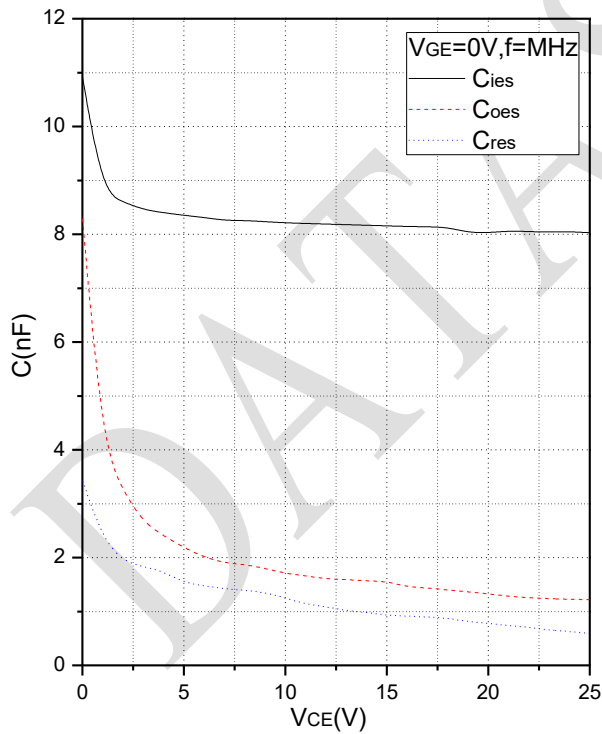


Fig.11 Capacitance Characteristics

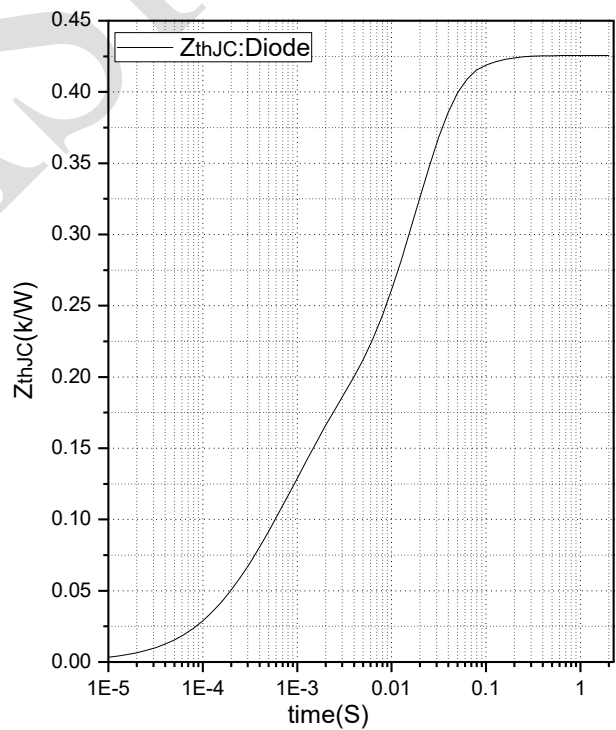
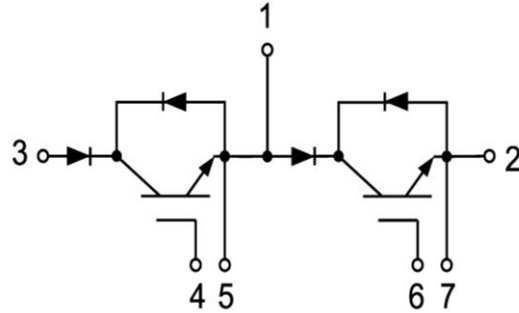


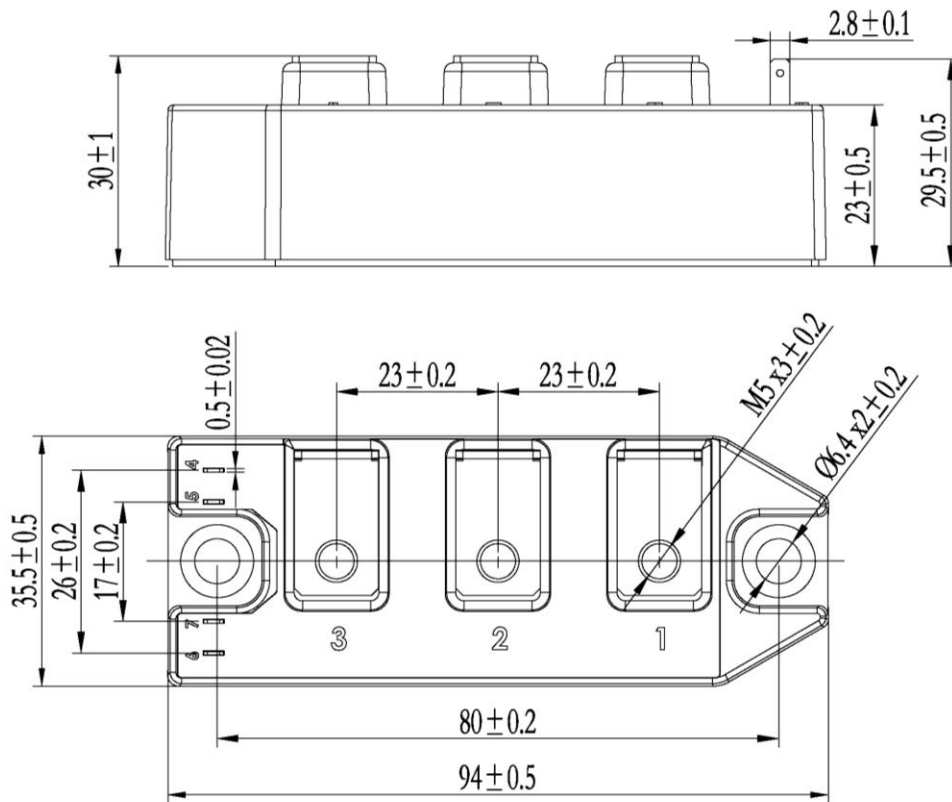
Fig.12 Transient Thermal Impedance-Clamp Diode



Internal Circuit



Package Outline (Unit: mm):





Date	Revision	Notes
12/23/2021	01	Initial Release

Announcement

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DATA SHEET